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Dimensions	
L	5.9mm +/-0.75mm
W	5mm +/-0.4mm
T	4.9mm +/-0.3mm
B	0.7mm +/-0.35mm

Packaging Specifications	
Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	900

General Information	
Series	KONNEKT Comm X7R
Style	KONNEKT
Description	SMD, MLCC, KONNEKT, Ultra-Stable, Class II
Features	High Density Packaging
RoHS	Yes
Termination	Flexible Termination
AEC-Q200	No
Component Weight	783.2 mg
Chip Size	2220-2
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	20 uF
Measurement Condition	120 Hz 0.5Vrms
Capacitance Tolerance	20%
Voltage DC	50 VDC
Dielectric Withstanding Voltage	125 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 120Hz 0.5Vrms
Dissipation Factor	2.5% 120 Hz 0.5Vrms
Aging Rate	3% Loss/Decade Hour
Insulation Resistance	25 MOhms

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